

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yong Kwun LEE	06/13/2011
Soo Jun LEE	06/13/2011
Hyeon Min LEE	06/13/2011
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13160656
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ASSIGNMENT

For valuable consideration, we,

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Yeongdeungpo-gu, Seoul 150-751, Republic of Korea

LEE, Soo Jun #923, Opiang 2, 829 Banghwa 3-dong, Gangseo-gu, Seoul
157-857, Republic of Korea

LEE, Hyeon Min Chungmu Jugong Apt. 212-1104, 872 Geumjeong-dong,
Gunpo-si, Gyeonggi-do 435-050, Republic of Korea

hereby assign to:

KOREA INSTITUTE OF SCIENCE AND TECHNOLOGY, a Republic of Korea
corporation/institute/institution having principal executive office(s) or place of business
at: 39-1 Hawolgok-dong, Seongbuk-gu, Seoul 136-791, Republic of Korea; and

its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of U.S. Patent Application Number 13/160,656 filed June 15, 2011 at the U.S. Patent & Trademark Office signed by us, with title MICRO COMPRESSOR and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and application serial number of said application when known; this Assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, preliminary statements and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

IN TESTIMONY/WITNESS WHEREOF, we, undersigned inventors (Assignors) intending to be legally bound, have hereto affixed our signatures.

This 13th day of June, 2011

Yong Kwon Lee

Signature: LEE, Yong Kwun

This 13th day of June, 2011

Lee Soo Jun

Signature: LEE, Soo Jun

This 13th day of June, 2011

Hyeon Min Lee

Signature: LEE, Hyeon Min